



P-Channel Enhancement Mode Power MOSFET

Description

The PE7280G uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. It can be used in a wide variety of applications.

General Features

- $V_{DS} = -20V$, $I_D = -80A$

$R_{DS(ON)} < 6m\Omega$ @ $V_{GS}=-10V$

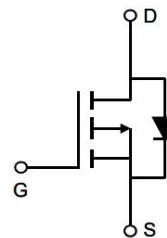
$R_{DS(ON)} < 7.2m\Omega$ @ $V_{GS}=-4.5V$

$R_{DS(ON)} < 11.2m\Omega$ @ $V_{GS}=-2.5V$

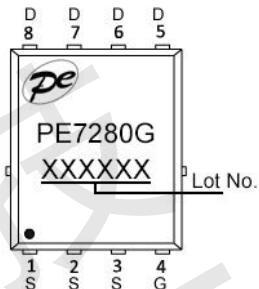
- High Power and current handing capability
- Lead free product is acquired
- Surface Mount Package

Application

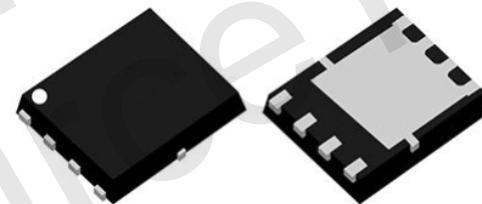
- PWM applications
- Load switch
- Power management



Schematic diagram



Marking and pin assignment



DFN5x6-8L

Absolute Maximum Ratings ($TC=25^\circ C$ unless otherwise noted)

| Parameter | Symbol | Rating | Unit |
|--|----------------|------------|------|
| Drain-Source Voltage | V_{DS} | -20 | V |
| Gate-Source Voltage | V_{GS} | ± 12 | V |
| Drain Current-Continuous ($TC=25^\circ C$) | I_D | -80 | A |
| Drain Current-Continuous ($TC=100^\circ C$) | I_D | -63 | A |
| Pulsed Drain Current (Note 1) | I_{DM} | -240 | A |
| Maximum Power Dissipation | P_D | 83 | W |
| Avalanche Current | I_{AS} | 60 | A |
| Avalanche Energy ($L=0.1mH$) | E_{AS} | 180 | mJ |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | -55 To 150 | °C |

Thermal Characteristic

| | | | |
|--------------------------------------|-----------------|-----|------|
| Thermal Resistance, Junction-to-Case | $R_{\theta JC}$ | 1.5 | °C/W |
|--------------------------------------|-----------------|-----|------|



Electrical Characteristics (TC=25°C unless otherwise noted)

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|---|--------------|--|-------|------|-----------|-----------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{GS}=0V, I_D=-250\mu A$ | -20 | - | - | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=-18V, V_{GS}=0V$ | - | - | -1 | μA |
| Gate-Body Leakage Current | I_{GSS} | $V_{GS}=\pm 12V, V_{DS}=0V$ | - | - | ± 100 | nA |
| On Characteristics (Note 3) | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=-250\mu A$ | -0.45 | -0.7 | -1 | V |
| Drain-Source On-State Resistance | $R_{DS(ON)}$ | $V_{GS}=-10V, I_D=-20A$ | - | 5 | 6 | $m\Omega$ |
| | | $V_{GS}=-4.5V, I_D=-20A$ | - | 6 | 7.2 | $m\Omega$ |
| | | $V_{GS}=-2.5V, I_D=-15A$ | - | 8 | 11.2 | $m\Omega$ |
| Forward Transconductance | g_{FS} | $V_{DS}=-5V, I_D=-20A$ | - | 95 | - | S |
| Dynamic Characteristics (Note 4) | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS}=-10V, V_{GS}=0V, F=1.0MHz$ | - | 4210 | - | pF |
| Output Capacitance | C_{oss} | | - | 650 | - | pF |
| Reverse Transfer Capacitance (Note 4) | C_{rss} | | - | 380 | - | pF |
| Switching Characteristics | | | | | | |
| Turn-on Delay Time | $t_{d(on)}$ | $V_{DD}=-10V, R_L=1\Omega, V_{GS}=-10V, R_G=3\Omega$ | - | 18 | - | nS |
| Turn-on Rise Time | t_r | | - | 32 | - | nS |
| Turn-Off Delay Time | $t_{d(off)}$ | | - | 126 | - | nS |
| Turn-Off Fall Time | t_f | | - | 59 | - | nS |
| Total Gate Charge | Q_g | $V_{DS}=-10V, I_D=-14A, V_{GS}=-4.5V$ | - | 44 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 9 | - | nC |
| Gate-Drain Charge | Q_{gd} | | - | 11 | - | nC |
| Drain-Source Diode Characteristics | | | | | | |
| Diode Forward Voltage (Note 3) | V_{SD} | $V_{GS}=0V, I_S=-1A$ | - | - | -1.2 | V |
| Diode Forward Current (Note 2) | I_S | | - | - | -15 | A |

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t \leq 10$ sec.
3. Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$.
4. Guaranteed by design, not subject to product.



Typical Electrical and Thermal Characteristics

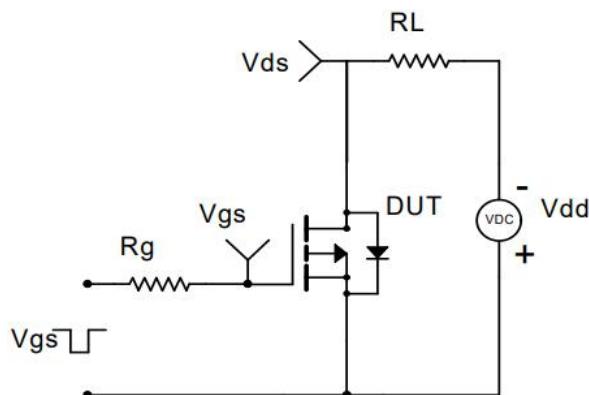


Figure 1 Switching Test Circuit

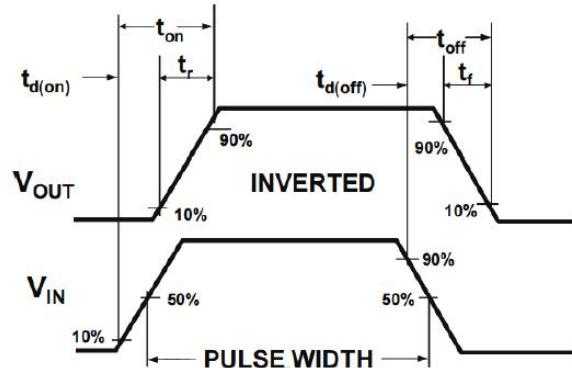
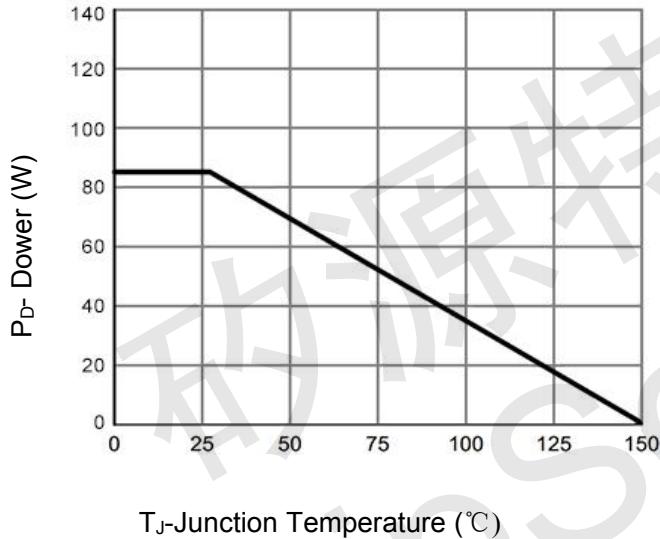
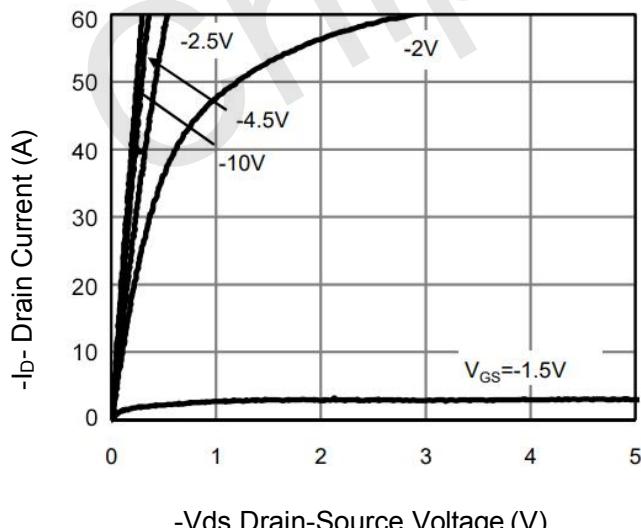


Figure 2 Switching Waveform



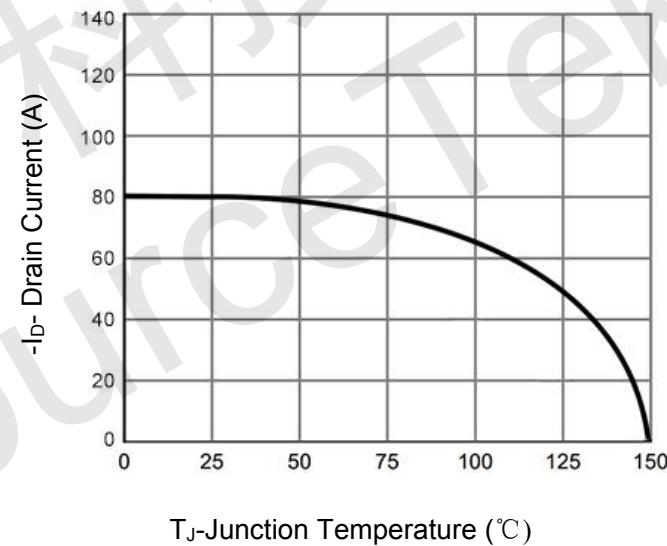
T_J-Junction Temperature (°C)

Figure 3 Power De-rating



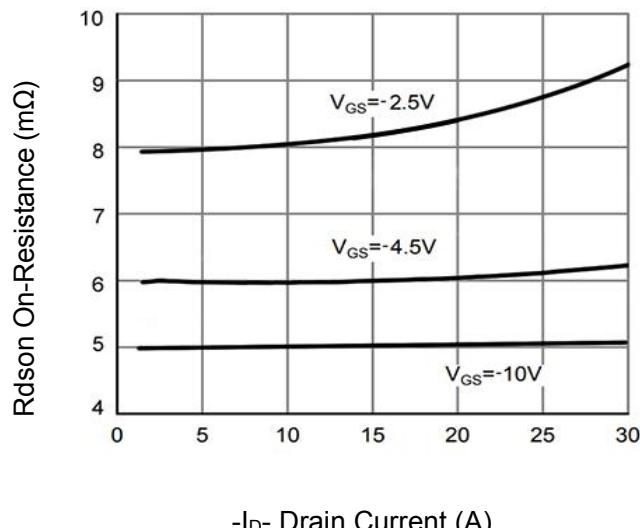
-Vds Drain-Source Voltage (V)

Figure 5 Output Characteristics



T_J-Junction Temperature (°C)

Figure 4 Drain Current



-ID- Drain Current (A)

Figure 6 Rdson vs Drain Current

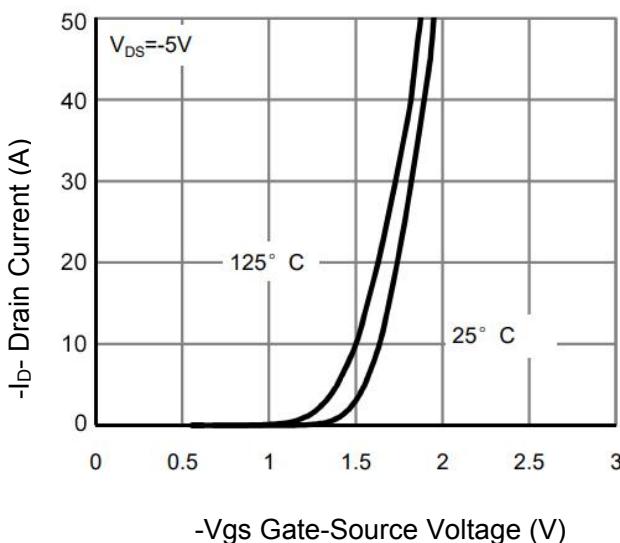


Figure 7 Transfer Characteristics

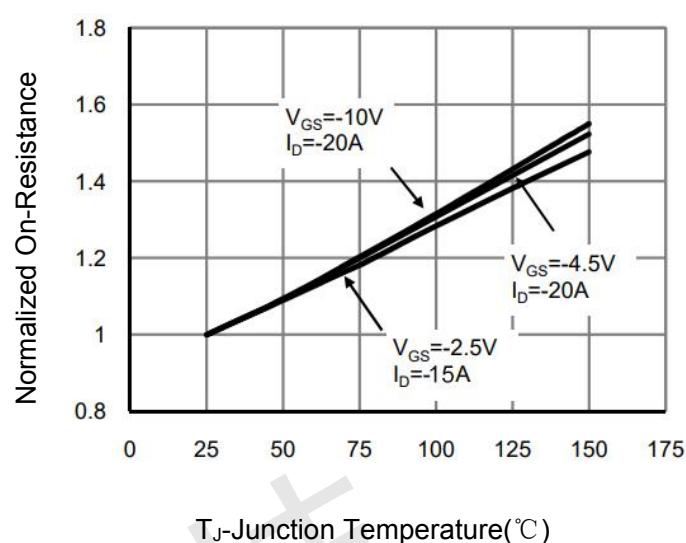


Figure 8 $R_{DS(on)}$ vs Junction Temperature

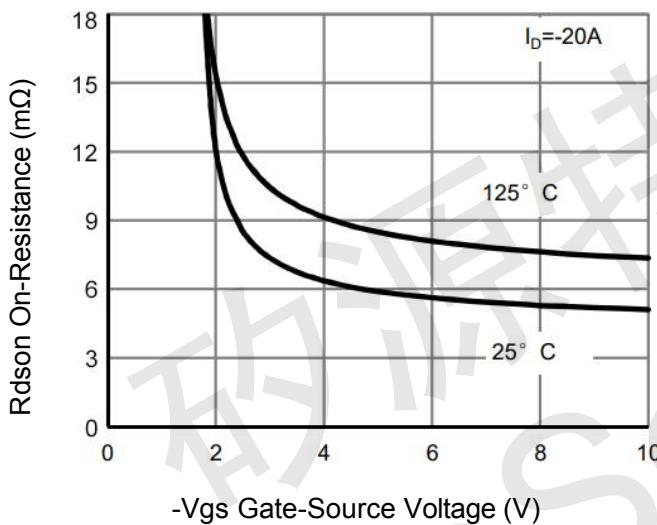


Figure 9 $R_{DS(on)}$ vs V_{GS}

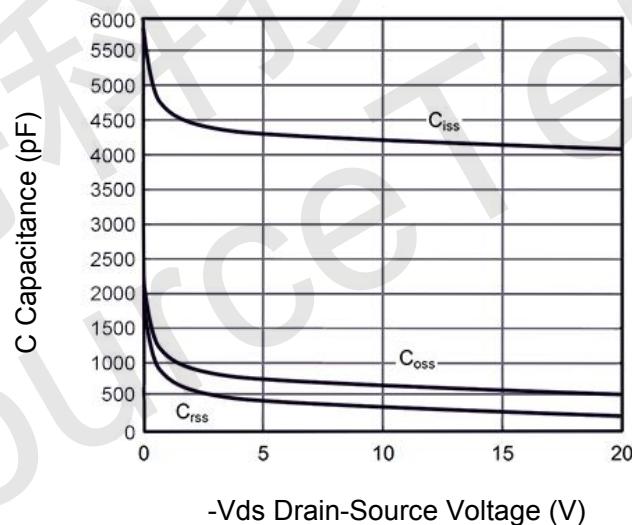


Figure 10 Capacitance vs V_{DS}

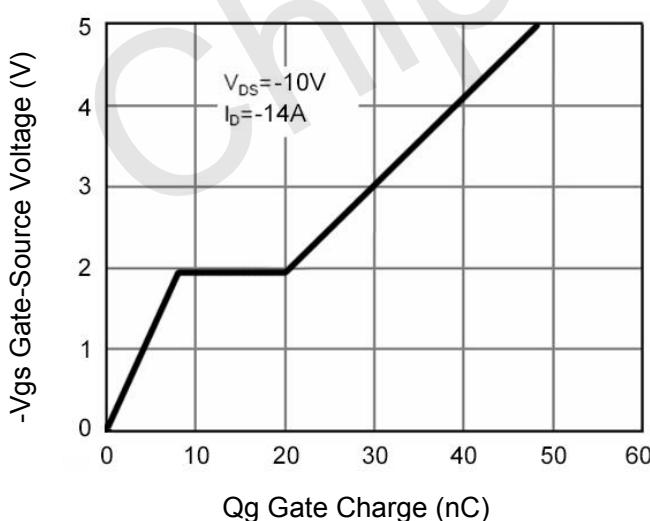


Figure 11 Gate Charge

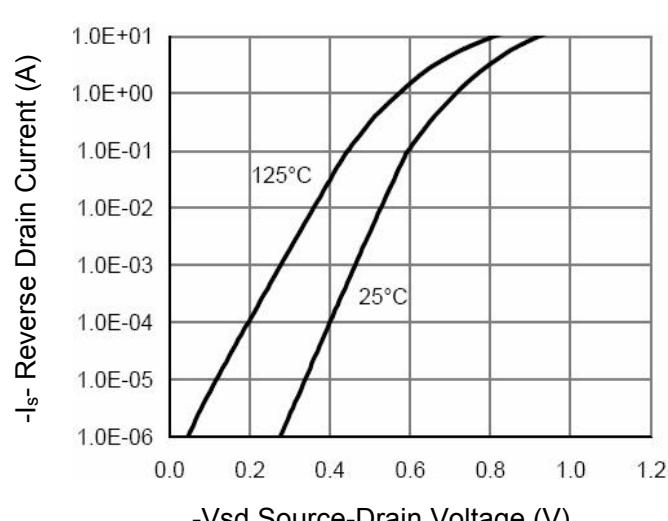


Figure 12 Source- Drain Diode Forward

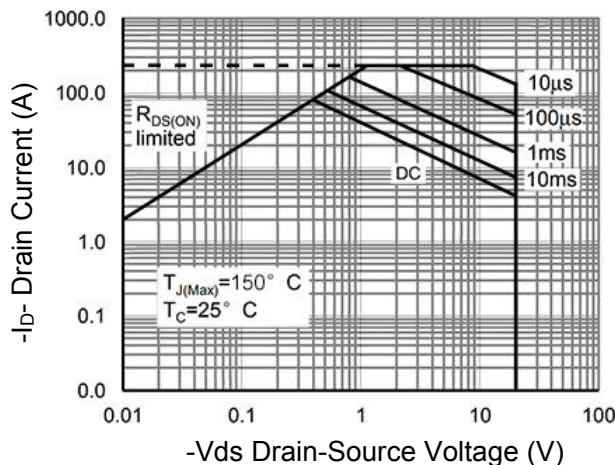


Figure 13 Safe Operation Area

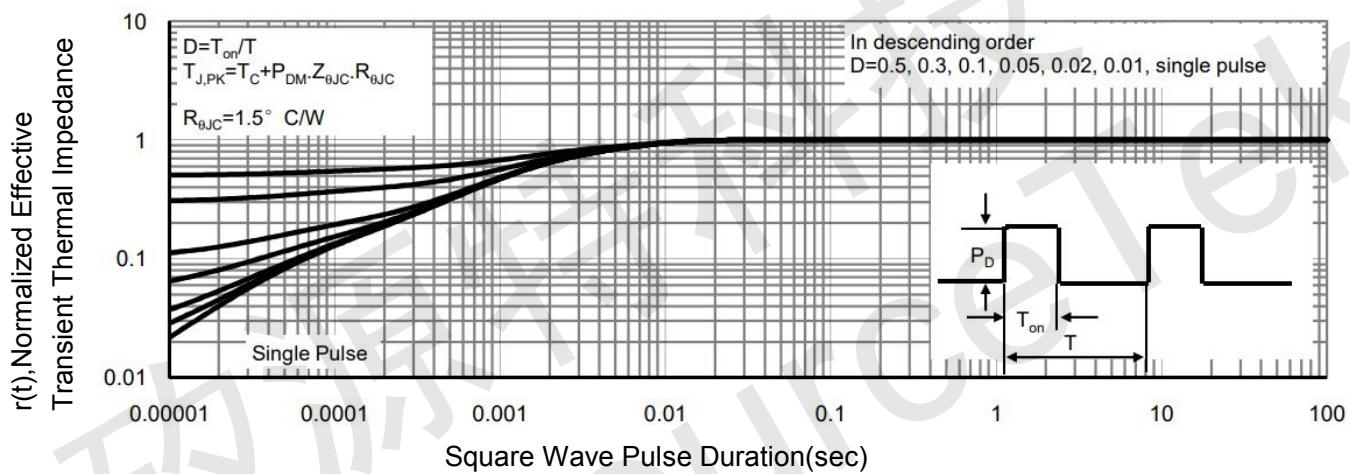
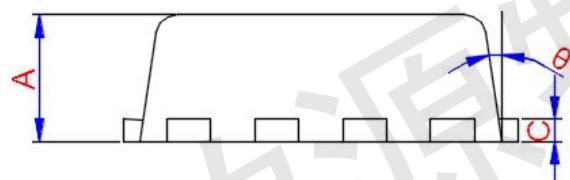
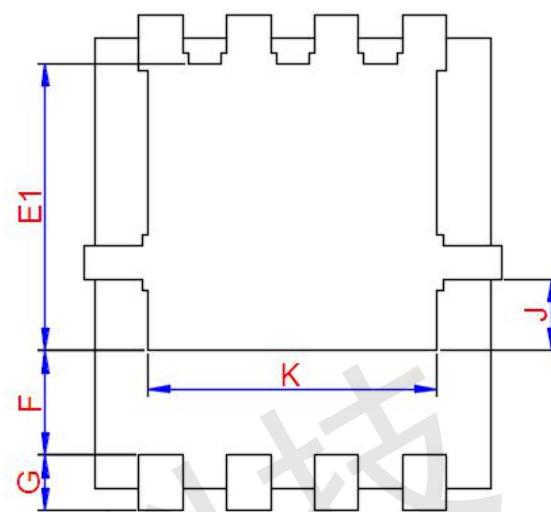
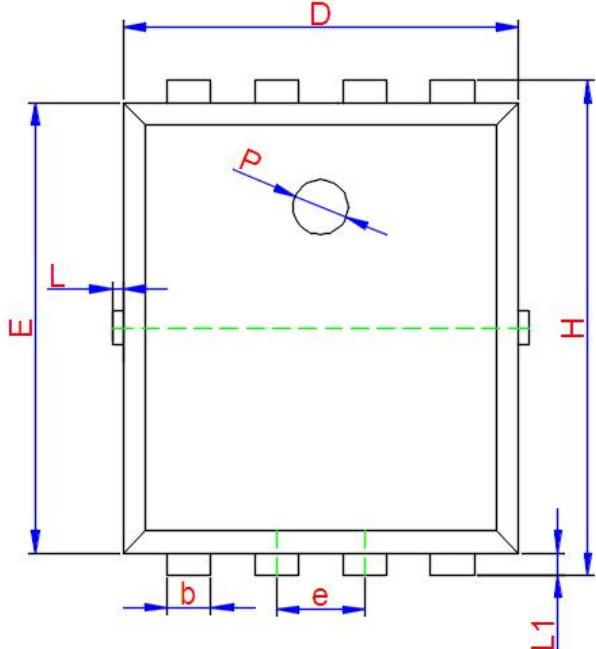


Figure 14 Normalized Maximum Transient Thermal Impedance



DFN5x6-8L Package Information



| Symbol | Dimensions In Millimeters | | |
|--------|---------------------------|-------|-------|
| | Min. | Typ. | Max. |
| A | 0.800 | 0.900 | 1.000 |
| b | 0.350 | 0.420 | 0.490 |
| c | 0.254TYP. | | |
| D | 4.900 | 5.000 | 5.100 |
| e | 1.270TYP. | | |
| E | 5.700 | 5.800 | 5.900 |
| E1 | 3.400TYP. | | |
| F | 1.400TYP. | | |
| G | 0.600TYP. | | |
| H | 5.950 | 6.080 | 6.200 |
| J | 0.950TYP. | | |
| K | 4.000TYP | | |
| L | - | - | 0.150 |
| L1 | 0.100 | 0.140 | 0.180 |
| P | 1.000TYP. | | |
| θ | 6° | 10° | 14° |